

# SST/U401 Series

## Monolithic N-Channel JFET Duals

**SST404  
SST406**

**U401  
U404**

### Product Summary

Part Number	V <sub>GS(off)</sub> (V)	V <sub>(BR)GSS</sub> Min (V)	g <sub>fS</sub> Min (mS)	I <sub>G</sub> Typ (pA)	V <sub>GS1</sub> – V <sub>GS2</sub>   Max (mV)
U401	-0.5 to -2.5	-40	1	-2	5
SST/U404	-0.5 to -2.5	-40	1	-2	15
SST/U406	-0.5 to -2.5	-40	1	-2	40

### Features

- Monolithic Design
- High Slew Rate
- Low Offset/Drift Voltage
- Low Gate Leakage: 2 pA
- Low Noise
- High CMRR: 102 dB

### Benefits

- Tight Differential Match vs. Current
- Improved Op Amp Speed, Settling Time Accuracy
- Minimum Input Error/Trimming Requirement
- Insignificant Signal Loss/Error Voltage
- High System Sensitivity
- Minimum Error with Large Input Signal

### Applications

- Wideband Differential Amps
- High-Speed,Temp-Compensated, Single-Ended Input Amps
- High-Speed Comparators
- Impedance Converters

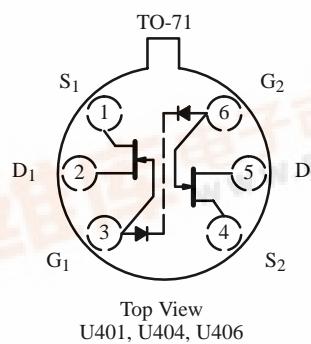
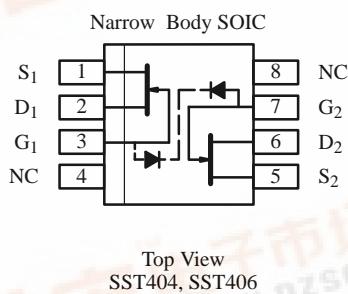
### Description

The SST/U401 series of high-performance monolithic dual JFETs features extremely low noise, tight offset voltage and low drift over temperature specifications, and is targeted for use in a wide range of precision instrumentation applications. This series has a wide selection of offset and drift specifications with the U401 featuring a 5-mV offset and 10- $\mu$ V/ $^{\circ}$ C drift.

The U series' hermetically sealed TO-71 package is

available with full military processing (see Military Information). The SST series SO-8 package provides ease of manufacturing, and the symmetrical pinout prevents improper orientation. The SO-8 package is available with tape-and-reel options for compatibility with automatic assembly methods (see Packaging Information).

For similar high-gain products in TO-78 packaging, see the 2N5911/5912 data sheet.



### Absolute Maximum Ratings

Gate-Drain, Gate-Source Voltage .....	-40 V
Gate Current .....	10 mA
Lead Temperature (1/16" from case for 10 sec.) .....	300°C
Storage Temperature :	
U Prefix .....	-65 to 200°C
SST Prefix .....	-55 to 150°C

Operating Junction Temperature ..... -55 to 150°C

Power Dissipation : Per Side<sup>a</sup> ..... 300 mW  
Total<sup>b</sup> ..... 500 mW

#### Notes

- a. Derate 2.4 mW/ $^{\circ}$ C above 25°C
- b. Derate 4 mW/ $^{\circ}$ C above 25°C

Updates to this data sheet may be obtained via facsimile by calling Siliconix FaxBack, 1-408-970-5600. Please request FaxBack document #70247. Applications information may also be obtained via FaxBack, request document #70599.

# SST/U401 Series

## Specifications<sup>a</sup>

Parameter	Symbol	Test Conditions	Typ <sup>b</sup>	Limits						Unit
				U401		SST/U404		SST/U406		
Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
<b>Static</b>										
Gate-Source Breakdown Voltage	V <sub>(BR)GSS</sub>	I <sub>G</sub> = -1 μA, V <sub>DS</sub> = 0 V	-58	-40		-40		-40		V
	V <sub>(BR)G1 - G2</sub>	I <sub>G</sub> = ±1 μA, V <sub>DS</sub> = 0 V V <sub>GS</sub> = 0 V	±45	±30		±30		±30		
Gate-Source Cutoff Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 1 nA	-1.5	-0.5	-2.5	-0.5	-2.5	-0.5	-2.5	
Saturation Drain Current <sup>c</sup>	I <sub>DSS</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V	3.5	0.5	10	0.5	10	0.5	10	mA
Gate Reverse Current	I <sub>GSS</sub>	V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V T <sub>A</sub> = 125°C	-2		-25		-25		-25	pA
		T <sub>A</sub> = 125°C	-1							nA
Gate Operating Current	I <sub>G</sub>	V <sub>DG</sub> = 15 V, I <sub>D</sub> = 200 μA T <sub>A</sub> = 125°C	-2		-15		-15		-15	pA
Drain-Source On-Resistance	r <sub>DS(on)</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 0.1 mA	250							Ω
Gate-Source Voltage	V <sub>GS</sub>	V <sub>DG</sub> = 15 V, I <sub>D</sub> = 200 μA	-1		-2.3		-2.3		-2.3	V
Gate-Source Forward Voltage	V <sub>GS(F)</sub>	I <sub>G</sub> = 1 mA, V <sub>DS</sub> = 0 V	0.7							
<b>Dynamic</b>										
Common-Source Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 200 μA f = 1 kHz	1.5	1	2	1	2	1	2	mS
Common-Source Output Conductance	g <sub>os</sub>		1.3		2		2		2	μS
Common-Source Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V f = 1 kHz	4	2	7	2	7	2	7	mS
Common-Source Output Conductance	g <sub>os</sub>		5		30		30		30	μS
Common-Source Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 200 μA f = 1 MHz	4		8		8		8	pF
Common-Source Reverse Transfer Capacitance	C <sub>rss</sub>		1.5		3		3		3	
Equivalent Input Noise Voltage	–e <sub>n</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 200 μA f = 10 Hz	10		20		20		20	nV/√Hz
<b>Matching</b>										
Differential Gate-Source Voltage	V <sub>GS1</sub> – V <sub>GS2</sub>	V <sub>DG</sub> = 10 V, I <sub>D</sub> = 200 μA			5		15		40	mV
Gate-Source Voltage Differential Change with Temperature	Δ V <sub>GS1</sub> – V <sub>GS2</sub>	V <sub>DG</sub> = 10 V I <sub>D</sub> = 200 μA T <sub>A</sub> = -55 to 125°C	SST404	20						μV/°C
	ΔT		SST406	40						
		All U			10		25		80	
Common Mode Rejection Ratio	CMRR	V <sub>DG</sub> = 10 to 20 V, I <sub>D</sub> = 200 μA	102	95		95				dB

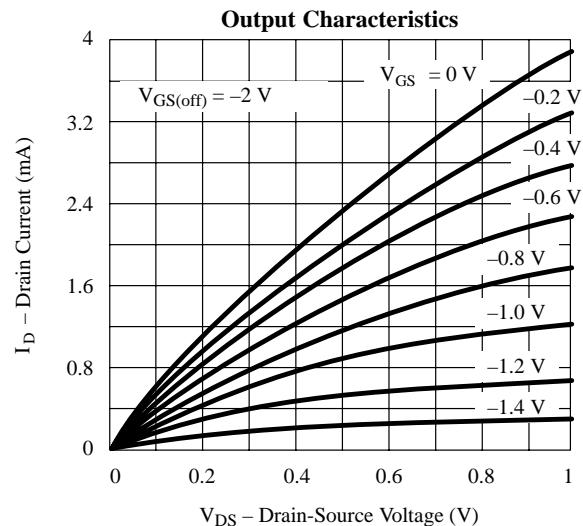
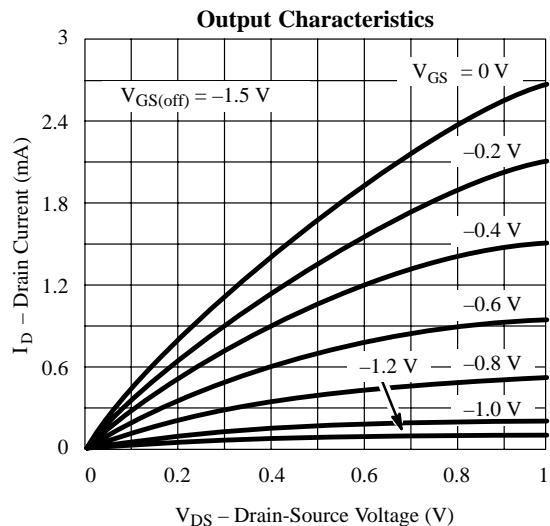
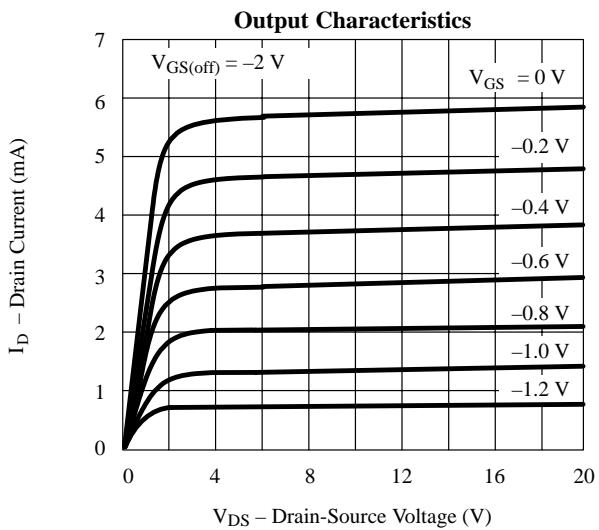
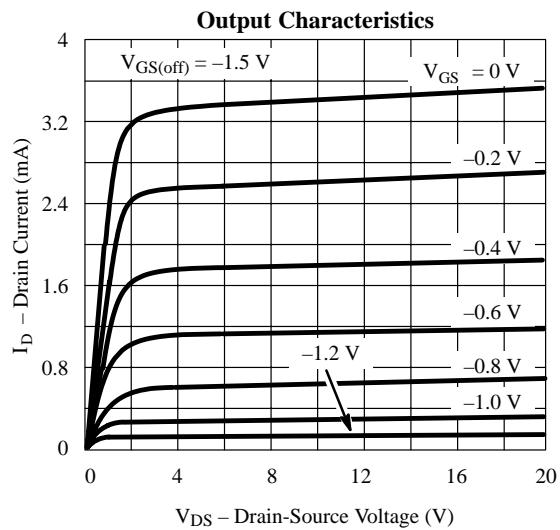
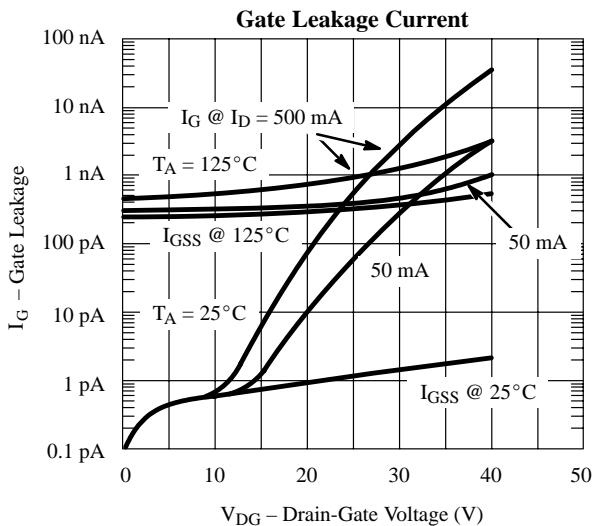
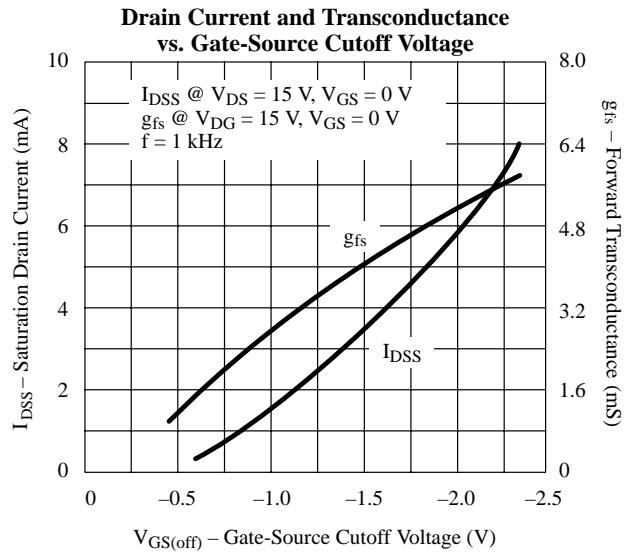
Notes

- a. T<sub>A</sub> = 25°C unless otherwise noted.
- b. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
- c. Pulse test: PW ≤ 300 μs duty cycle ≤ 3%.

NNR

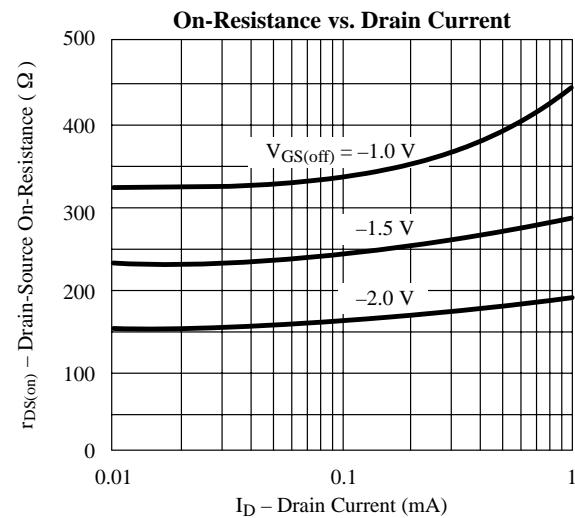
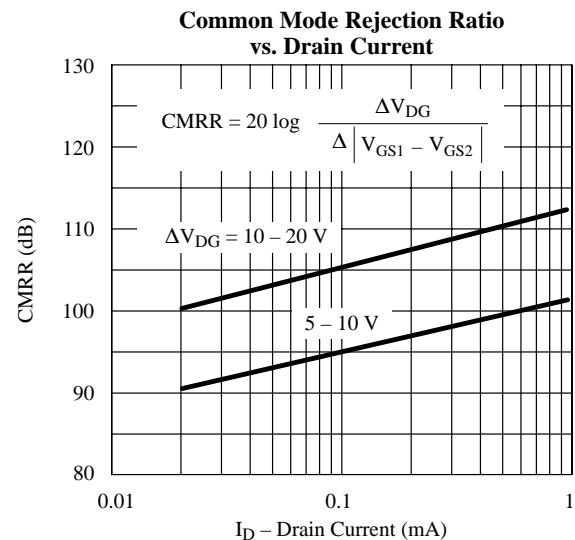
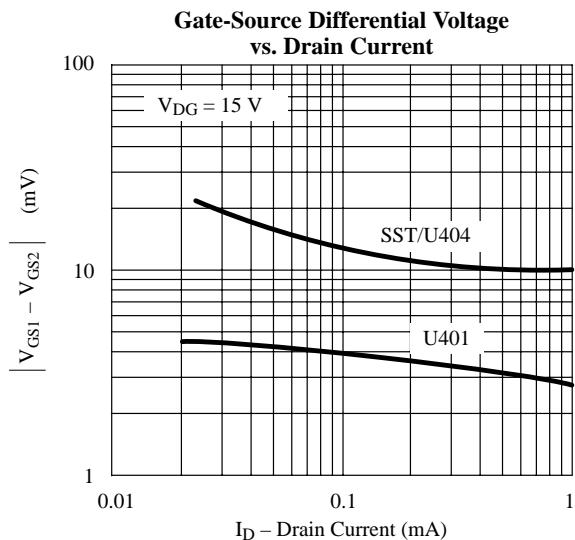
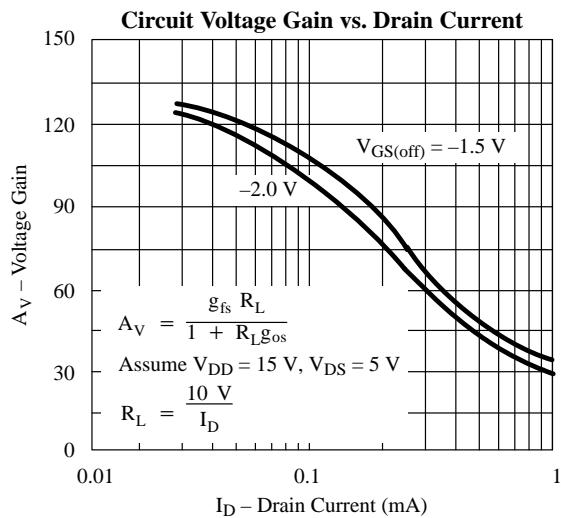
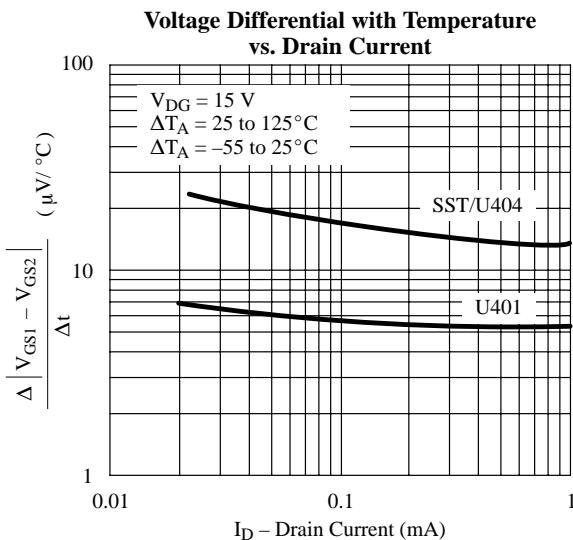
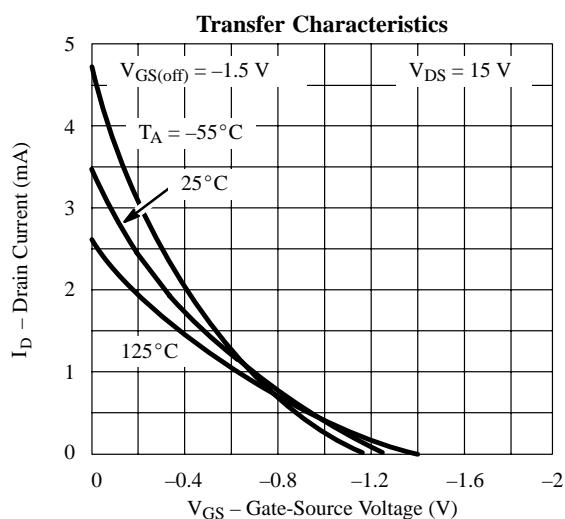
# SST/U401 Series

## Typical Characteristics



# SST/U401 Series

## Typical Characteristics (Cont'd)



# SST/U401 Series

## Typical Characteristics (Cont'd)

